

Helping Customers Innovate, Improve & Grow




VC-826

Description

Vectron's VC-826 Crystal Oscillator is a quartz stabilized, differential output oscillator, operating off a 2.5 or 3.3 volt power supply in a hermetically sealed 3.2 x 2.5mm ceramic package.

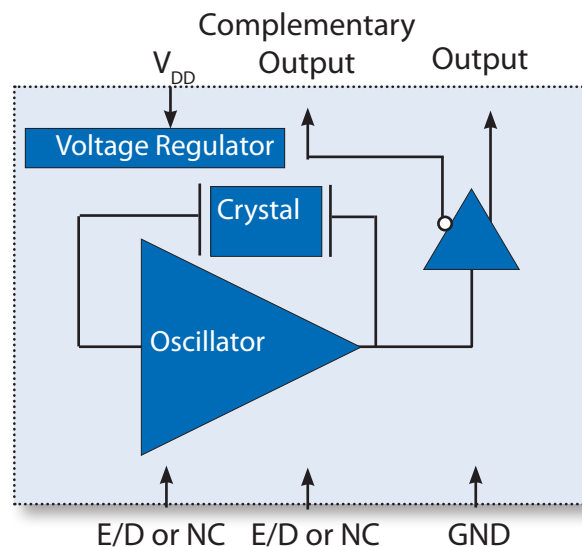
Features

- Ultra Low Jitter Performance, 3rd OT or Fundamental Crystal Design
- 20MHz -170MHz Output Frequencies
- Low Power
- Excellent Power Supply Rejection Ratio
- Enable/Disable
- 3.3 or 2.5V operation
- -10/70°C or -40/85°C Operation
- Hermetically Sealed 3.2x2.5mm Ceramic Package
- Product is compliant to RoHS directive  and fully compatible with lead free assembly

Applications

- Ethernet, GbE, Synchronous Ethernet
- Fiber Channel
- Enterprise Servers
- Telecom
- Clock source for A/D's, D/A's
- Driving FPGA's
- Test and Measurement
- PON
- Medical
- COTS

Block Diagram



Performance Specifications

Table 1. Electrical Performance, LVPECL Option					
Parameter	Symbol	Min	Typical	Maximum	Units
Voltage ¹	V_{DD}	3.135 2.375	3.3 2.5	3.465 2.625	V V
Current ² , 3.3V 2.5V	I_{DD}			45 42	mA
Frequency					
Nominal Frequency	f_N	20		170	MHz
Stability ³ (Ordering Option)		±25, ±50 or ±100			ppm
Outputs					
Output Logic Levels ²					
Output Logic High	V_{OH}	$V_{DD}-1.025$		$V_{DD}-0.880$	V
Output Logic Low	V_{OL}	$V_{DD}-1.810$		$V_{DD}-1.620$	V
Output Rise and Fall Time ²	t_R/t_F			500	ps
Load		50 ohms into $V_{DD}-1.3V$			
Duty Cycle ⁴		45		55	%
Phase Noise, 3.3V, 100MHz ⁵					dBc/Hz
10Hz			-70		
100Hz			-100		
1kHz			-126		
10kHz			-140		
100kHz			-146		
1MHz			-149		
20MHz			-157		
40MHz			-157		
Jitter ⁵ , 100MHz 12kHz -20MHz	ϕ_J		170	200	fs
Enable/Disable					
Outputs Enabled ⁶	V_{IH}	$0.7*V_{DD}$			V
Outputs Disabled	V_{IL}			$0.3*V_{DD}$	V
Disable Time	t_D			200	ns
Enable/Disable Leakage Current				±200	uA
Start-Up Time	t_{SU}			10	ms
Operating Temp. (Ordering Option)	T_{OP}	-10/70 or -40/85			°C
Package Size		3.2 x 2.5 x 1.05			mm

1. The VC-826 power supply pin should be filtered, eg, a 10uf, 0.1uf and 0.01uf capacitor.
2. Figure 1 defines the test circuit and Figure 2 defines these parameters.
3. Includes calibration tolerance, operating temperature, supply voltage variations, aging and IR reflow.
4. Duty Cycle is defined as the On/Time Period.
5. Measured using an Agilent E5052 Signal Source Analyzer at 25 °C.
6. Outputs will be Enabled if Enable/Disable is left open.

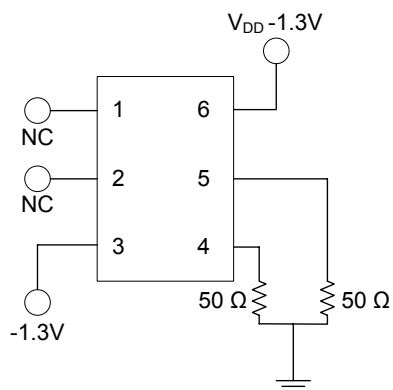


Figure 1.

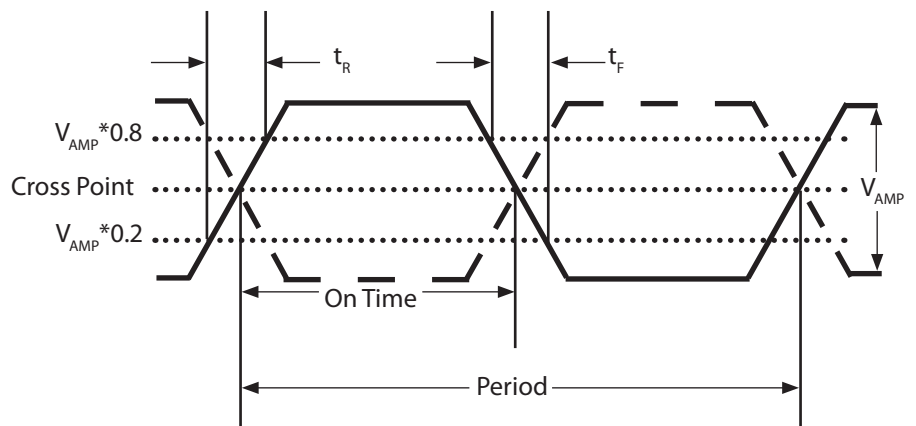


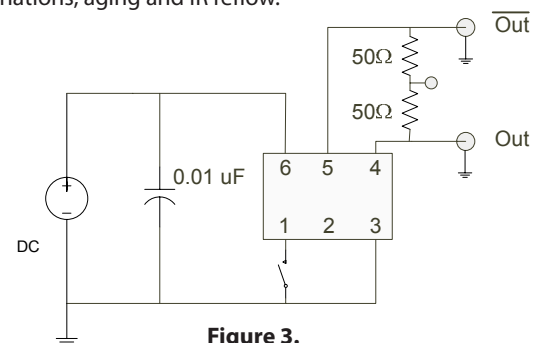
Figure 2.

Performance Specifications

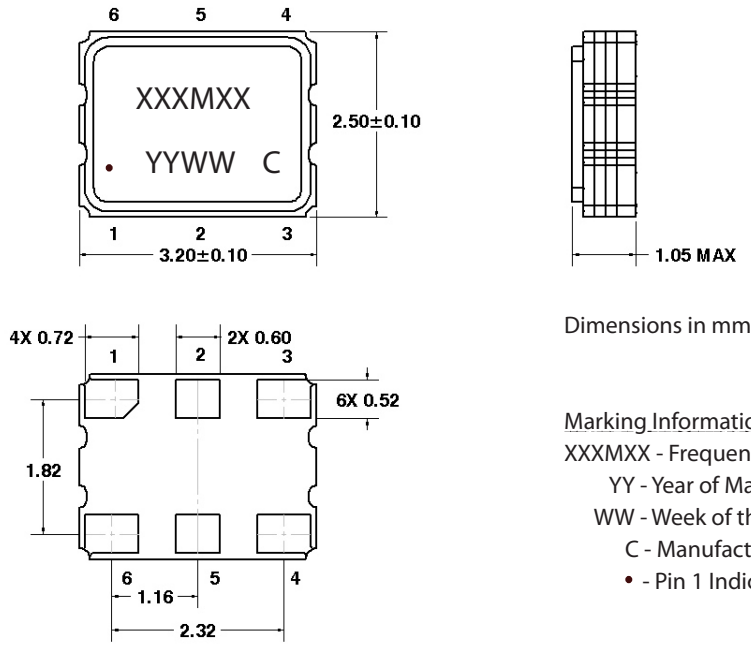
Table 2. Electrical Performance, LVDS Option

Parameter	Symbol	Min	Typical	Maximum	Units
Supply					
Voltage ¹	V_{DD}	3.135 2.375	3.3 2.5	3.465 2.625	V V
Current ² , 3.3V 2.5V	I_{DD}			17 14	mA
Frequency					
Nominal Frequency	f_N	20		170	MHz
Stability ³ (Ordering Option)		±25, ±50 or ±100			ppm
Outputs					
Output Logic Levels ² Output Logic High Output Logic Low	V_{OH} V_{OL}	0.9	1.43 1.10	1.6	V V
Output Amplitude		247	350	454	mV
Differential Output Error				50	mV
Offset Voltage		1.125	1.25	1.375	V
Offset Voltage Error				50	mV
Output Leakage Current, Outputs Disabled				10	uA
Output Rise and Fall Time ³	t_R/t_F			500	ps
Load		100 ohms differential			
Duty Cycle ⁴		45		55	%
Phase Noise, 3.3V, 100MHz ⁵ 10Hz 100Hz 1kHz 10kHz 100kHz 1MHz 20MHz 40MHz			-73 -101 -128 -140 -147 -150 -156 -156		dBc/Hz
Jitter ⁵ , 100MHz 12kHz - 20MHz	ϕ_J		170	200	fs
Enable/Disable					
Outputs Enabled ⁶ Outputs Disabled	V_{IH} V_{IL}	0.7* V_{DD}		0.3* V_{DD}	V V
Disable Time	t_D			200	ns
Enable/Disable Leakage Current	$I_{E/D}$			±200	uA
Start-Up Time	t_{SU}			10	ms
Operating Temp. (Ordering Option)	T_{OP}	-10/70 or -40/85			°C
Package Size		3.2 x 2.5 x 1.05			mm

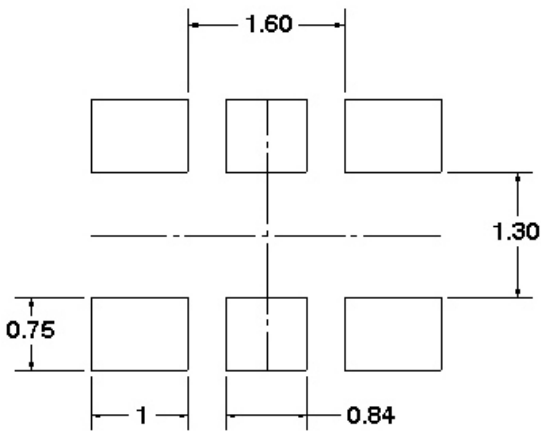
1. The VC-826 power supply pin should be filtered, eg, a 10uf, 0.1uf and 0.01uf capacitor.
2. Figure 2 defines these parameters and Figure 3 defines the test circuit.
3. Includes calibration tolerance, operating temperature, supply voltage variations, aging and IR reflow.
4. Duty Cycle is defined as the On/Time Period.
5. Measured using an Agilent E5052 Signal Source Analyzer at 25 °C
6. Outputs will be Enabled if Enable/Disable is left open.


Figure 3.

Package Outline Drawing



Recommended Pad Layout

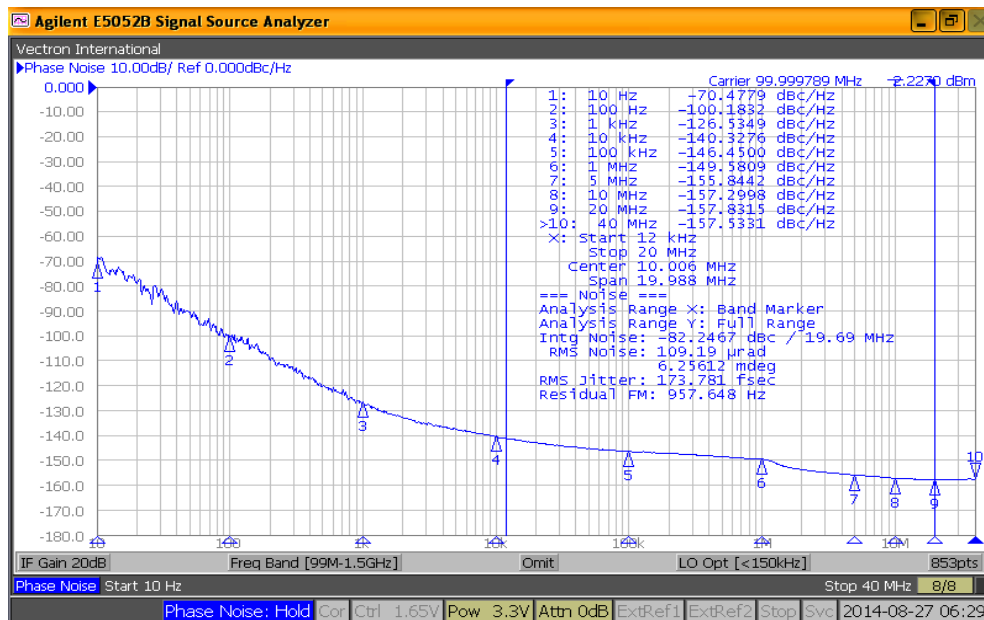


Pin Diagram

Table 3. Pinout

Pin #	Symbol	Function
1	E/D or NC	Enable/Disable or No Connection
2	E/D or NC	Enable/Disable or No Connection
3	GND	Electrical and Lid Ground
4	f_o	Output Frequency
5	Cf_o	Complementary Output Frequency
6	V_{DD}	Supply Voltage

Phase Noise (LV-PECL Output)



LVPECL Application Diagrams

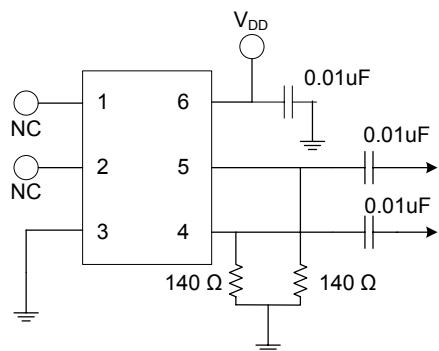


Figure 4. Single Resistor Termination Scheme
Resistor values are typically 140 ohms for 3.3V operation and 84 ohms for 2.5V operation.

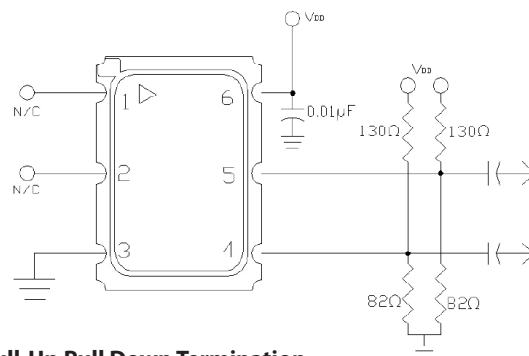


Figure 5. Pull-Up Pull Down Termination
Resistor values shown are typical for 3.3 V operation. For 2.5V operation, the resistor to ground is 62 ohms and the resistor to supply is 250 ohms

The VC-826 incorporates a standard PECL output scheme, which are un-terminated FET drains. There are numerous application notes on terminating and interfacing PECL logic and the two most common methods are a single resistor to ground, Figure 4, or for best 50 ohm matching a pull-up/pull-down scheme as shown in Figure 5 should be used. AC coupling capacitors are optional, depending on the application and the input logic requirements of the next stage.

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left un-terminated, and if it one of the two outputs is left open it will result in excessive jitter on both. PC board layout must take this and 50 ohm impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

LVDS Application Diagrams

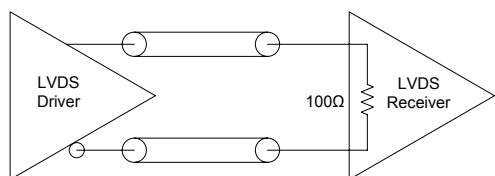


Figure 6. LVDS to LVDS Connection, Internal 100ohm Resistor
Some LVDS structures have an internal 100 ohm resistor on the input and do not need additional components. AC blocking capacitors can be used if the DC levels are incompatible.

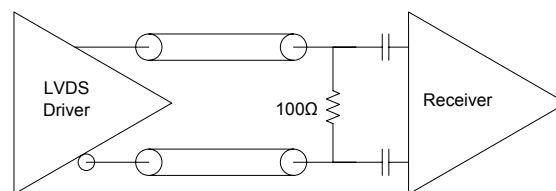


Figure 7. LVDS to LVDS Connection
Some input structures may not have an internal 100 ohm resistor on the input and will need an external 100ohm resistor for impedance matching. Also, the input may have an internal DC bias which may not be compatible with LVDS levels, AC blocking capacitors can be used.

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left un-terminated, and if it one of the two outputs is left open it will result in excessive jitter on both. PC board layout must take this and 50 ohm impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

Environmental and IR Compliance

Table 4. Environmental Compliance	
Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002
Mechanical Vibration	MIL-STD-883 Method 2007
Temperature Cycle	MIL-STD-883 Method 1010
Solderability	MIL-STD-883 Method 2003
Fine and Gross Leak	MIL-STD-883 Method 1014
Resistance to Solvents	MIL-STD-202 Method 215
Moisture Sensitivity Level	MSL1
Contact Pads	Gold (0.3-1.0um) over Nickel

IR Compliance

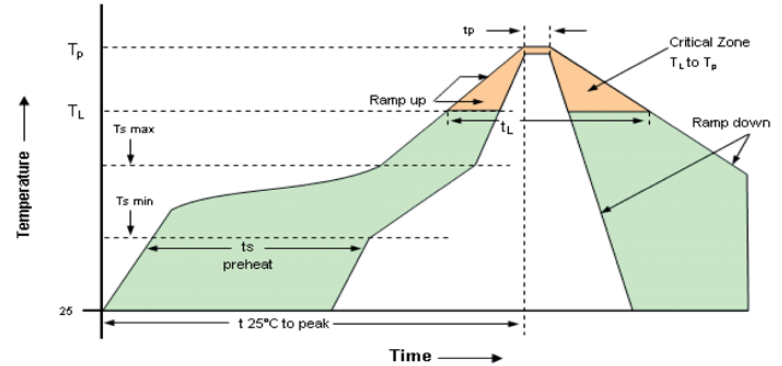
Suggested IR Profile

Devices are built using lead free epoxy and can be subjected to standard lead free IR reflow conditions shown in Table 5. Contact pads are gold over nickel and lower maximum temperatures can also be used, such as 220C.

Table 5. Reflow Profile

Parameter	Symbol	Value
PreHeat Time	t_s	200 sec Max
Ramp Up	R_{UP}	3°C/sec Max
Time above 217°C	t_L	150 sec Max
Time to Peak Temperature	t_{AMB-P}	480 sec Max
Time at 260°C	t_P	30 sec Max
Time at 240°C	t_{P2}	60 sec Max
Ramp down	R_{DN}	6°C/sec Max

Solderprofile:



Maximum Ratings, Tape & Reel

Absolute Maximum Ratings and Handling Precautions

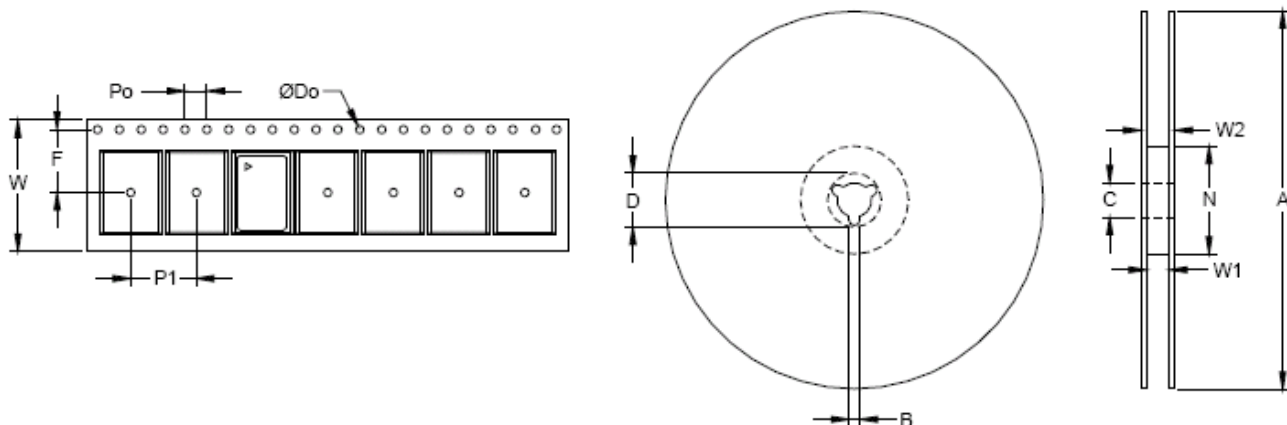
Stresses in excess of the absolute maximum ratings can permanently damage the device. Functional operation is not implied or any other excess of conditions represented in the operational sections of this data sheet. Exposure to absolute maximum ratings for extended periods may adversely affect device reliability. Although ESD protection circuitry has been designed into the VC-826, proper precautions should be taken when handling and mounting, VI employs a Human Body Model and Charged Device Model for ESD susceptibility testing and design evaluation. ESD thresholds are dependent on the circuit parameters used to define the model. Although no industry standard has been adopted for the CDM a standard resistance of 1.5kOhms and capacitance of 100pF is widely used and therefor can be used for comparison purposes.

Table 6. Maximum Ratings

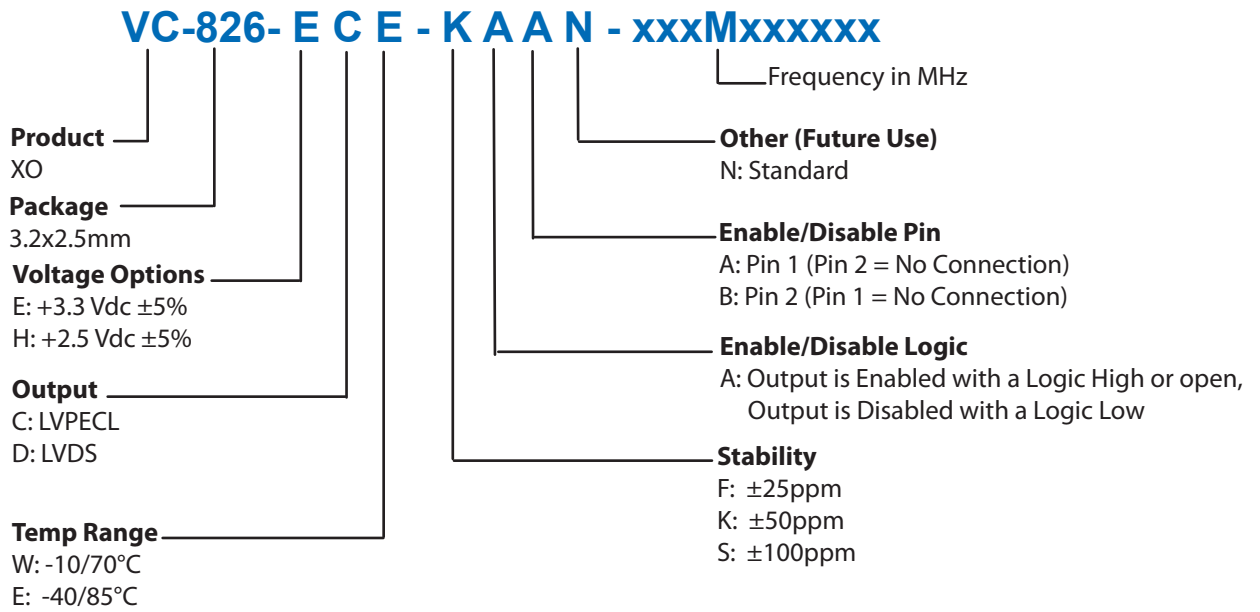
Parameter		Unit
Storage Temperature	-55 to 125	°C
Junction Temperature	150	C
Supply Voltage	-0.5 to 5.0	V
Enable Disable Voltage	-0.5 to $V_{DD} + 0.5$	V
ESD, Human Body Model	1500	V
ESD, Charged Device Model	1500	V

Table 7. Tape and Reel Information

Tape Dimensions (mm)						Reel Dimensions (mm)						
W	F	Do	Po	P1	A	B	C	D	N	W1	W2	#/Reel
8	3.5	1.5	4	4	178	2	13	21	60	10	14	1000



Ordering Information



Example: VC-826-ECE-KAAN-100M000000

For Additional Information, Please Contact

USA:

Vectron International
267 Lowell Road Unit 102
Hudson, NH 03051
Tel: 1.888.328.7661
Fax: 1.888.329.8328

Europe:

Vectron International
Landstrasse, D-74924
Neckarbischofsheim, Germany
Tel: +49 (0) 3328.4784.17
Fax: +49 (0) 3328.4784.30

Asia:

VI Shanghai
68 Yin Cheng Road(C), 22nd Floor
One LuJiaZui
Pudong, Shanghai 200120, China
Tel: 86.21.6194.6886
Fax: 86.21.6194.6699

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Rev: 04/27/2016 VN

Revision History

Revision Date	Approved	Description
Sep 05, 2014	VN	VC-826 Product Initial Release.
Dec 12, 2014	VN	Added min and max values for LVDS output amplitude.
Apr 27, 2016	VN	Updated LVDS 100MHz noise information and added maximum jitter numbers.